

C3D06060F–Silicon Carbide Schottky Diode

Z-REC™ RECTIFIER (FULL-PAK)

$$V_{RRM} = 600 \text{ V}$$

$$I_{F(AVG)} = 6 \text{ A}$$

$$Q_c = 16 \text{ nC}$$

Features

- 600-Volt Schottky Rectifier
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature-Independent Switching Behavior
- Extremely Fast Switching
- Positive Temperature Coefficient on V_F
- Fully Isolated Case

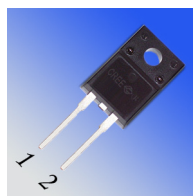
Benefits

- Replace Bipolar with Unipolar Rectifiers
- Essentially No Switching Losses
- Higher Efficiency
- Reduction of Heat Sink Requirements
- Parallel Devices Without Thermal Runaway

Applications

- Switch Mode Power Supplies
- Power Factor Correction

Package



TO-220-F2



Part Number	Package	Marking
C3D06060F	TO-220-F2	C3D06060

Maximum Ratings

Symbol	Parameter	Value	Unit	Test Conditions	Note
V_{RRM}	Repetitive Peak Reverse Voltage	600	V		
V_{RSM}	Surge Peak Reverse Voltage	600	V		
V_{DC}	DC Blocking Voltage	600	V		
$I_{F(AVG)}$	Average Forward Current	6	A	$T_C = 60^\circ\text{C}$, DC	
I_{FRM}	Repetitive Peak Forward Surge Current	27 18	A	$T_C = 25^\circ\text{C}$, $t_p = 10 \text{ ms}$, Half Sine Wave, $D = 0.3$ $T_C = 110^\circ\text{C}$, $t_p = 10 \text{ ms}$, Half Sine Wave, $D = 0.3$	
I_{FSM}	Non-Repetitive Peak Forward Surge Current	44 41	A	$T_C = 25^\circ\text{C}$, $t_p = 10 \text{ ms}$, Half Sine Wave, $D = 0.3$ $T_C = 110^\circ\text{C}$, $t_p = 10 \text{ ms}$, Half Sine Wave, $D = 0.3$	
I_{FSM}	Non-Repetitive Peak Forward Surge Current	200	A	$T_C = 25^\circ\text{C}$, $t_p = 10 \mu\text{s}$, Pulse	
P_{tot}	Power Dissipation	17 7.4	W	$T_C = 25^\circ\text{C}$ $T_C = 110^\circ\text{C}$	
T_J, T_{stg}	Operating Junction and Storage Temperature	-55 to +175	$^\circ\text{C}$		
	TO-220 Mounting Torque	1 8.8	Nm lbf-in	M3 Screw 6-32 Screw	

Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V_F	Forward Voltage	1.6 1.9	1.8 2.4	V	$I_F = 6\text{ A}$ $T_J = 25^\circ\text{C}$ $I_F = 6\text{ A}$ $T_J = 175^\circ\text{C}$	
I_R	Reverse Current	10 20	50 200	μA	$V_R = 600\text{ V}$ $T_J = 25^\circ\text{C}$ $V_R = 600\text{ V}$ $T_J = 175^\circ\text{C}$	
Q_C	Total Capacitive Charge	16		nC	$V_R = 600\text{ V}$, $I_F = 6\text{ A}$ $di/dt = 500\text{ A}/\mu\text{s}$ $T_J = 25^\circ\text{C}$	
C	Total Capacitance	294 27 26		pF	$V_R = 0\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 200\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$ $V_R = 400\text{ V}$, $T_J = 25^\circ\text{C}$, $f = 1\text{ MHz}$	

Note:

1. This is a majority carrier diode, so there is no reverse recovery charge.

Thermal Characteristics

Symbol	Parameter	Typ.	Unit
$R_{\theta JC}$	Thermal Resistance from Junction to Case	8.8	$^\circ\text{C}/\text{W}$

Typical Performance

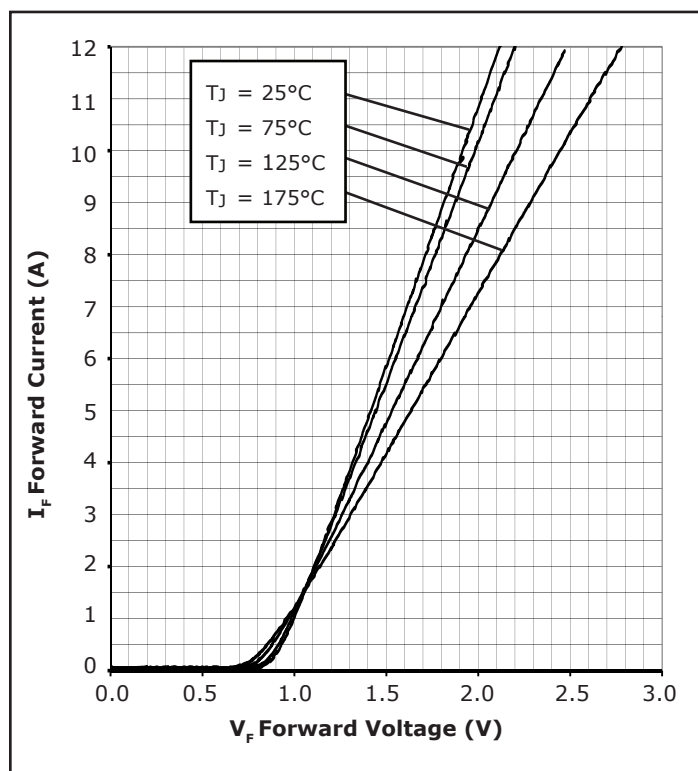


Figure 1. Forward Characteristics

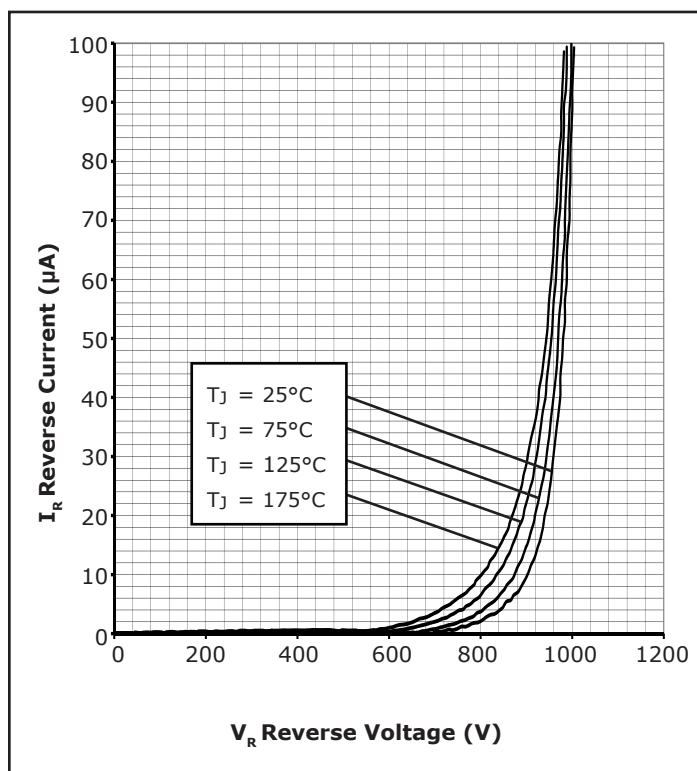


Figure 2. Reverse Characteristics

Typical Performance

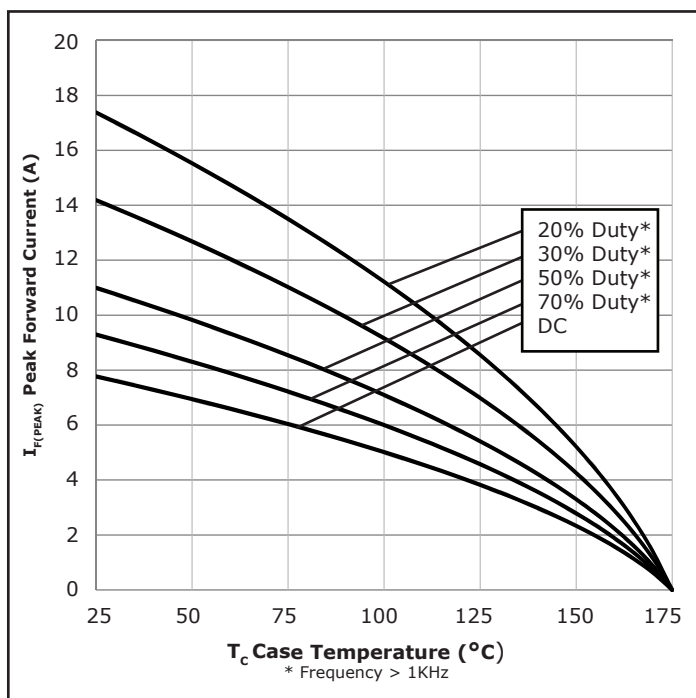


Figure 3. Current Derating

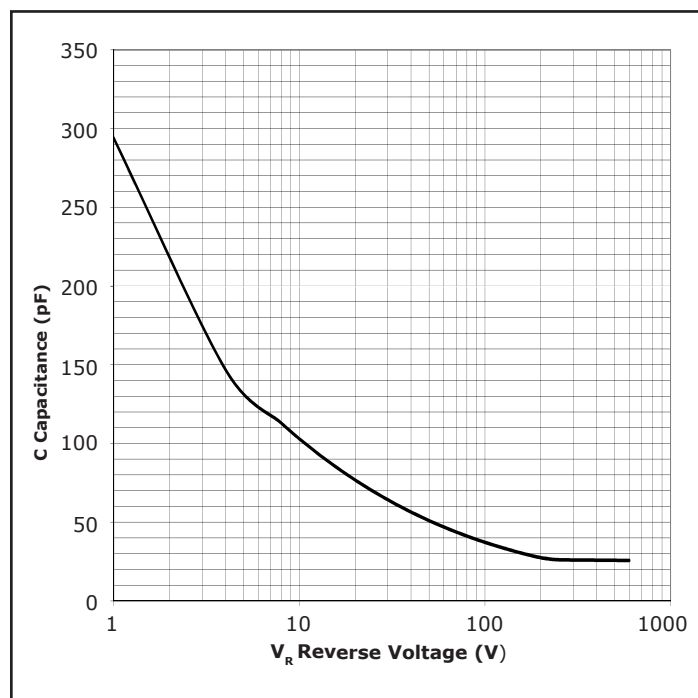


Figure 4. Capacitance vs. Reverse Voltage

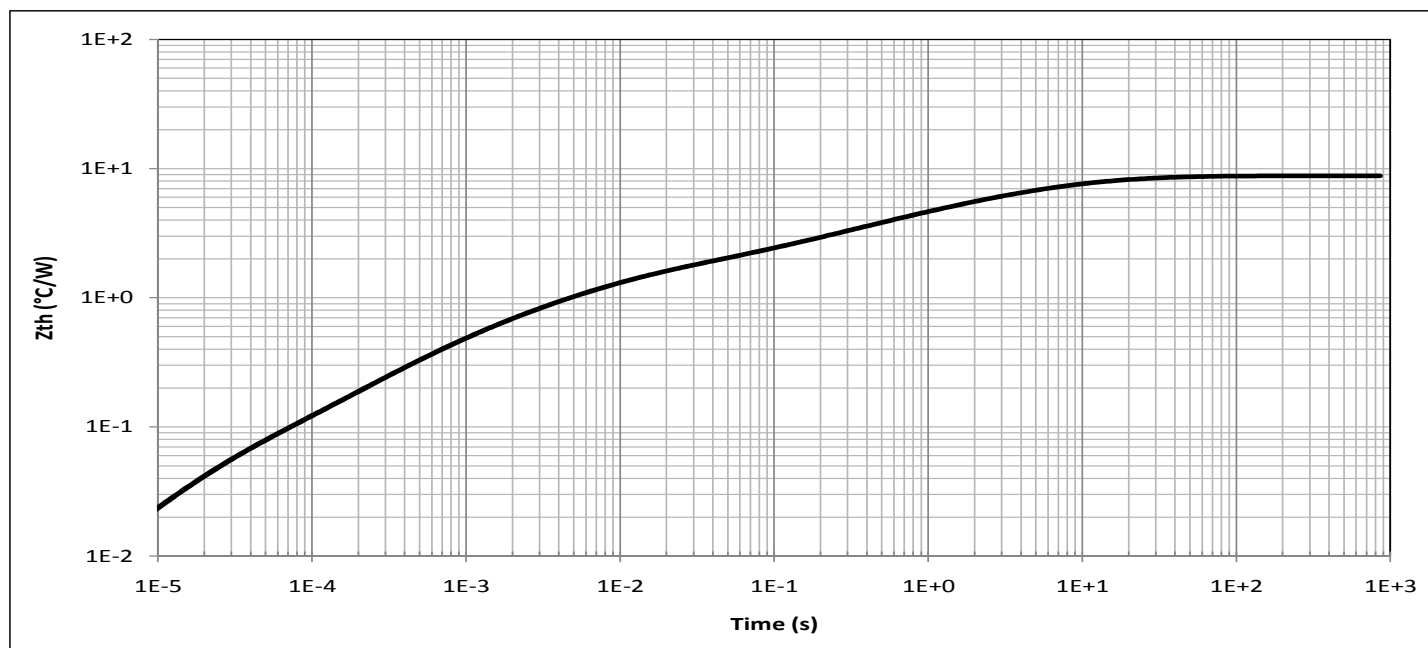


Figure 5. Transient Thermal Impedance

Typical Performance

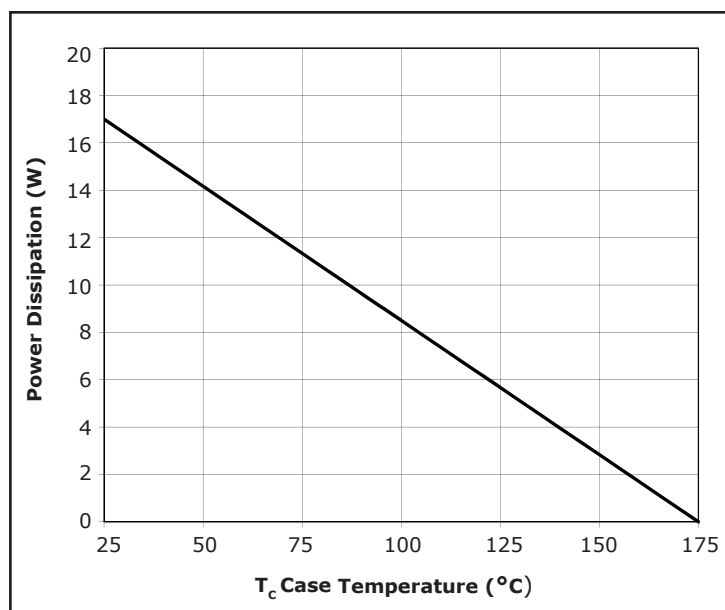
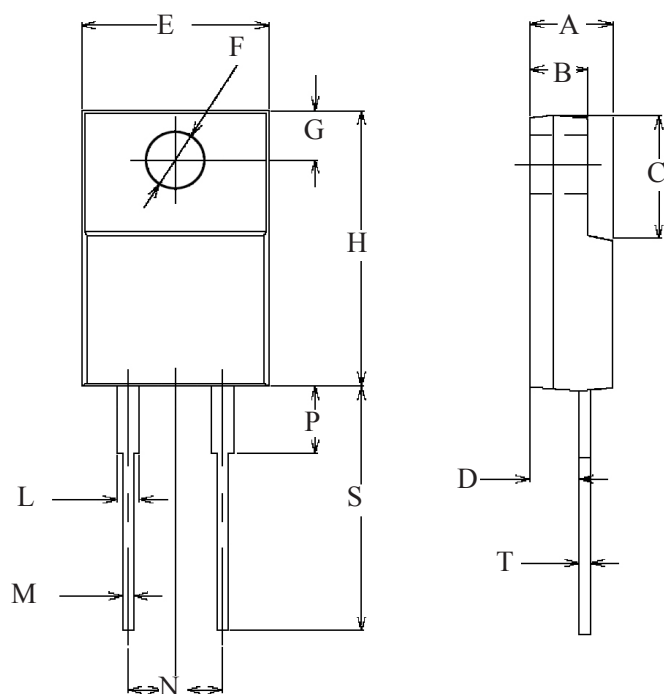


Figure 6. Power Derating

Package Dimensions

Package TO-220-F2

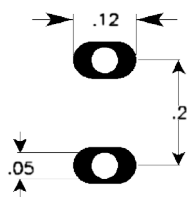


POS	Inches		Millimeters	
	Min	Max	Min	Max
A	.177	.193	4.5	4.9
B	.092	.108	2.34	2.74
C	.248	.272	6.3	6.9
D	.098	.114	2.5	2.9
E	.390	.406	9.9	10.3
F	.118	.134	3.0	3.4
G	.122	.137	3.1	3.5
H	.617	.633	15.67	16.07
L	.039	.055	1.0	1.4
M	.016	.031	0.4	0.8
N	.185	.217	4.7	5.5
P	0	.154	0	3.9
S	.476	.508	12.1	13.18
T	.016	.031	0.4	0.8

NOTE:

1. Dimension L, M, T apply for Solder Dip Finish

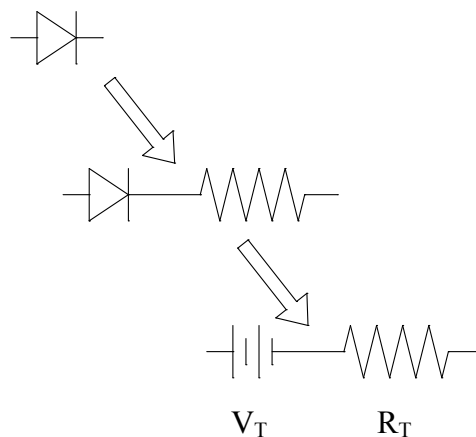
Recommended Solder Pad Layout



TO-220-2

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C3D06060F	TO-220-F2	C3D06060

Diode Model



$$V_{fT} = V_T + I_f \cdot R_T$$

$$V_T = 0.975 + (T_j \cdot -1.0 \cdot 10^{-3})$$

$$R_T = 0.09 + (T_j \cdot 0.51 \cdot 10^{-3})$$

Note: T_j = Diode Junction Temperature In Degrees Celcius